

Terbium-based extreme ultraviolet multilayers

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We have fabricated periodic multilayers that comprise either Si/Tb or SiC/Tb bilayers, designed to operate as narrowband reflective coatings near 60 nm wavelength in the extreme ultraviolet (EUV). We find peak reflectance values in excess of 20% near normal incidence. The spectral bandpass of the best Si/Tb multilayer was measured to be 6.5 nm full width at half-maximum (FWHM), while SiC/Tb multilayers have a more broad response, of order 9.4 nm FWHM. Transmission electron microscopy analysis of Si/Tb multilayers reveals polycrystalline Tb layers, amorphous Si layers, and relatively large asymmetric amorphous interlayers. Thermal annealing experiments indicate excellent stability to 100°C (1 h) for Si/Tb. These new multilayer coatings have the potential for use in normal incidence instrumentation in a region of the EUV where efficient narrowband multilayers have not been available until now. In particular, reflective Si/Tb multilayers can be used for solar physics applications where the coatings can be tuned to important emission lines such as O V near 63.0 nm and Mg X near 61.0 nm. © 2005 Optical Society of America
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Narrowband reflective multilayer coatings operating near normal incidence in the extreme ultraviolet (EUV) band have by now found wide application in a number of disciplines, including solar physics, photolithography, short-wavelength lasers, plasma diagnostics, etc. While peak reflectance values as high as 70% have been obtained at the short-wavelength end of the EUV near 13 nm, at longer wavelengths the performance of even the best coatings is considerably lower. The limit on multilayer performance at long wavelengths is primarily due to absorption in the constituent materials; an ideal EUV multilayer would comprise materials with low absorption so that the incident radiation can penetrate deeply into the multilayer stack, thereby allowing for the coherent addition of reflections from a large number of layer interfaces. But with high-absorption materials only a few interfaces can contribute to the reflection process, thereby limiting the ultimate performance.

Our principal motivation for the development of long-wavelength EUV multilayers is directed at the production of narrowband imaging telescopes for solar physics. A number of important coronal emission lines in the 60–65 nm band, including O V near 63.0 nm and Mg X near 61.0 nm, could be observed if efficient narrowband multilayer coatings were available. Multilayer imagers that could be tuned to these wavelengths would nicely complement currently available multilayers that operate at shorter wavelengths, and that have been used in satellite instruments such as SoHO/EIT,¹ TRACE,² and the SDO/AIA³ instrument currently under development,

all of which have been limited to wavelengths shorter than 34 nm.

In recent years narrowband multilayer performance has been extended to longer EUV wavelengths with materials such as Mg and Sc: SiC/Mg multilayers⁴ show high reflectance in the range 25–40 nm, i.e., below the Mg K edge near 25 nm (and will be used in the SDO/AIA instrument), while Si/Sc multilayers⁵ operate with relatively high efficiency in the 35–50 nm range, i.e., below the 3*p*–3*d* absorption “window” for this material. However, at wavelengths longer than ~50 nm the development of efficient multilayers has been limited thus far by a dearth of suitable multilayer materials having sufficiently low absorption.

We have identified the rare-earth elements, with partially filled 5*d* and 5*f* levels, as candidate materials having transmission windows at wavelengths longer than 50 nm. Tb in particular was found to have low absorption in the 60–70 nm range.⁶ The Tb transmission data, obtained by measuring with synchrotron radiation the transmittance of Tb films of varying thickness deposited directly onto Si photodiodes,⁷ are shown in Fig. 1. Driven by these results we have investigated new EUV multilayers comprising Si/Tb and SiC/Tb bilayers designed for normal incidence reflectance in this same wavelength band. Our optical constants determination work will be described in detail elsewhere; we present our multilayer results here.

Multilayer films were deposited by dc magnetron sputtering in argon, using a system that has been de-

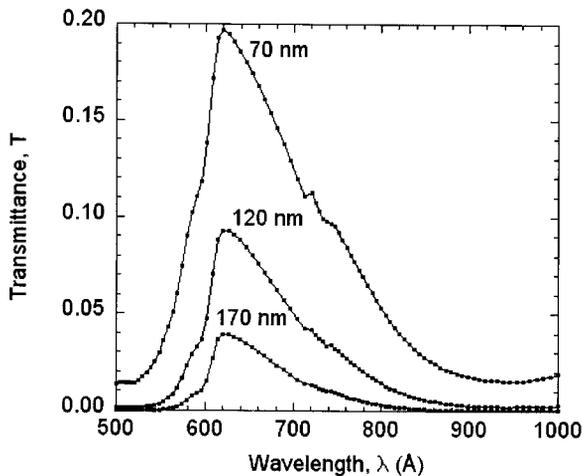


Fig. 1. Measured transmission of Tb films having the thicknesses indicated, as a function of wavelength.

scribed in detail previously.⁸ The coating system utilizes *S*-gun cathodes, which were operated in constant-power mode. The base pressure of the coating chamber was in the range $(2-3) \times 10^{-7}$ Torr. With an Ar flow rate of ~ 6 sccm the Ar pressure was maintained at 2.0 mTorr. Si/Tb and SiC/Tb multilayer films were grown on 16×16 mm Si wafer segments cleaved from polished 3-in. (100) wafers. Effective deposition rates of order 0.04 nm/s were obtained for Tb (30 W applied power), 0.04 nm/s for Si (45 W), and 0.03 nm/s for SiC (30 W).

Grazing incidence x-ray reflectance (XRR) measurements were made in the $\theta-2\theta$ geometry using a system comprising a sealed-tube Cu anode operating at 1.3 kW and a Ge crystal monochromator tuned to the Cu $K\alpha$ line (8 keV). Fits⁹ to the measured XRR data were used to determine multilayer periods and the layer thickness ratio Γ , defined here as the Si or SiC layer thickness divided by the multilayer period d .

EUV reflectance measurements were made as a function of wavelength at 5° from normal at beamline X24C at the National Synchrotron Light Source. The absolute energy scale of the grating monochromator was calibrated by measuring the Sn and In absorption edges (using filters made from these elements) at 23.97 and 16.70 eV, respectively. The absolute reflectance was computed as the reflected beam intensity divided by the incident intensity as measured with the same Si photodiode for each wavelength from roughly 49 to 80 nm.

Preliminary reflectance calculations (made by using our measured optical constants for Tb and optical constants for Si and SiC from Refs. 10 and 11) suggested that the reflectance and spectral bandpass of Si/Tb and SiC/Tb multilayers varies predictably with Γ such that an optimal Γ value should exist that yields high peak reflectance and a relatively narrow spectral response. However, the experimental reflectance data obtained with a series of Si/Tb and SiC/Tb multilayers for which the Γ value was varied systematically and the period adjusted to keep the peak wavelength constant—the so-called “through- Γ series”—revealed that, while the spectral bandpass

does indeed increase with Γ as expected, the peak reflectance is relatively insensitive to Γ variations over the range $\sim 0.2-0.6$.

The Si/Tb and SiC/Tb films found to have the highest peak reflectance and smallest spectral bandpasses from our through- Γ investigations are shown in Fig. 2. We find peak reflectance values of $\sim 22\%$ at $\lambda \sim 60$ nm for both films. The spectral bandpass of the Si/Tb film was measured to be 6.5 nm FWHM, while SiC/Tb multilayers have a more broad response, of order 9.4 nm FWHM. For films designed to operate at somewhat longer wavelengths the spectral bandpass increased further; for example, a SiC/Tb film peaking near 67 nm was found to have a 12.5 nm FWHM bandpass.

The individual layer thicknesses for these films were estimated by fitting the measured EUV reflectance curves. We find for the Si/Tb film having $N = 10$ bilayers shown in Fig. 2 a period $d = 30.2$ nm and $\Gamma = 0.26$, while the SiC/Tb film has $N = 10$, $d = 31.0$ nm, and $\Gamma = 0.30$. Comparing the EUV fits with equivalent fits to the XRR data reveals significant discrepancies between the d and Γ values determined from each technique. For example, in the case of the Si/Tb film shown in Fig. 2, fixing the layer thickness ratio to $\Gamma = 0.26$ (so as to be consistent with the EUV fit) the XRR data yields $d = 31.8$ nm, i.e., a difference in period of 1.6 nm between the two techniques. Furthermore, relatively large interface widths, of order $\sigma = 2.8$ nm, are required for acceptable fits to the EUV data.

The large σ values determined from the EUV data suggest the possibility of substantial intermixing at the Si-Tb and SiC-Tb interfaces. This possibility has been confirmed, at least for the case of Si/Tb, by high-resolution transmission electron microscopy (TEM) analysis. Cross-sectional TEM images of selected samples were made by Accurel Systems International,¹² with thinned samples prepared using a focused ion-beam technique. Shown in Fig. 3 is a TEM image of the Si/Tb film in Fig. 2 described above. The polycrystalline and strongly textured Tb layers have a thickness of order 7 nm, while the

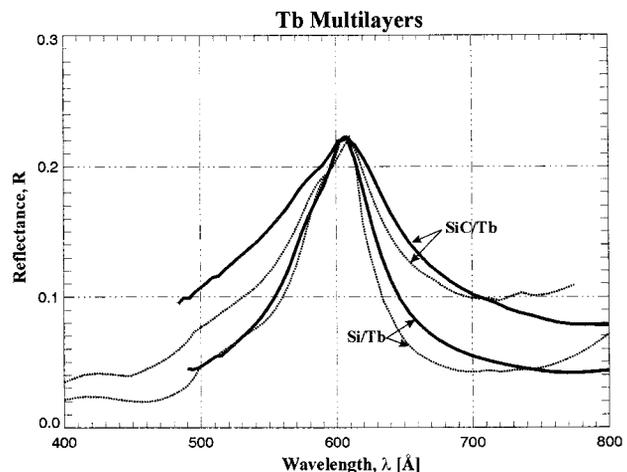


Fig. 2. Reflectance at 5° incidence of Si/Tb and SiC/Tb multilayers as indicated. Solid lines are measured lines; dotted lines are fits.

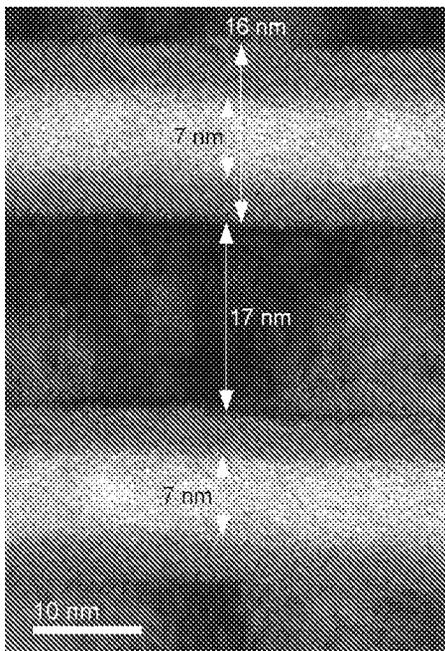


Fig. 3. High-resolution TEM image of the Si/Tb film shown in Fig. 2.

amorphous Si layers have a thickness of 17 nm. Asymmetric amorphous interlayers can be clearly identified in the image, with the Tb-on-Si interlayer having a thickness of order 4 nm, while the Si-on-Tb interface is somewhat thicker, of order 5 nm. The 33 nm period determined from TEM analysis is greater than the 31.8 nm XRR period and the 30.2 nm EUV period.

These discrepancies in the layer thicknesses inferred from EUV, XRR, and TEM analyses may be explained by the optical effects of the large amorphous Si-Tb interlayers identified by TEM. That is, these interlayer regions almost certainly have optical constants that differ from either the pure Si or Tb layers. If the optical constants of these interlayers were known in the EUV and x-ray bands, presumably they could be included in a four-layer model to better fit the measured reflectance data. But unfortunately not even the density and exact composition of these interlayers, let alone the EUV optical constants, are known at present. Consequently, we are not able to accurately model our data and reconcile the apparent discrepancies in the fit parameters at present.

The thermal stability of Si/Tb and SiC/Tb multilayers was investigated by performing 1 h annealing in air at 100°C, 200°C, and 300°C for prototype films. The annealed films were compared with the as-deposited films using both XRR and EUV reflectance measurements. We find that in the case of Si/Tb, the peak EUV reflectance was essentially unchanged after the 100°C anneal; however, the reflectance peak shifted by 0.2 nm towards shorter wavelengths (corresponding to a period decrease of ~0.1 nm). After the 200°C anneal the reflectance showed a relative decrease of 10%, and the reflectance peak shifted by another 1.1 nm. The XRR data were consistent with these period changes, and further indicated that after the 300°C anneal the multilayer structure had

changed drastically; the EUV reflectance of the 300°C annealed film was not measured.

In the case of SiC/Tb films, much smaller period shifts (less than 0.1 nm) were identified after thermal annealing to 200°C. However, a 5% relative decrease in peak EUV reflectance was measured after the 100°C anneal, and another 5% decrease was measured after the 200°C anneal. Again, because of the drastic change in period after the 300°C anneal as inferred from XRR measurements, the EUV reflectance was not measured for this sample.

The combination of relatively high peak reflectance (22%), narrow spectral response (6.5 nm FWHM), and good thermal stability to 100°C of the Si/Tb multilayer shown in Figs. 2 and 3 make this coating an attractive candidate for a narrowband imager tuned near 60 nm. For solar physics applications additional suppression of nearby emission lines will likely be necessary as well, to achieve sufficient spectral "purity." For this purpose Tb thin-film filters currently under study may provide a viable solution when used in conjunction with reflective Si/Tb multilayers. Looking to the future, the possibility of diffusion barrier layers deposited between the Si and Tb layers (as has been already demonstrated, e.g., in Si/W/Sc multilayers¹³), might make it possible to achieve even higher peak reflectance and greater spectral selectivity; the use of such diffusion barrier layers is currently under study.

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